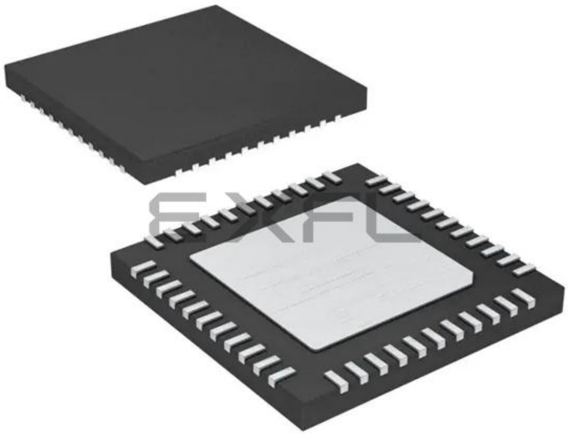

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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	16-Bit
Speed	32MHz
Connectivity	I²C, IrDA, SPI, UART/USART, USB OTG
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	33
Program Memory Size	64KB (22K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	A/D 13x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-VQFN Exposed Pad
Supplier Device Package	44-QFN (8x8)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24fj64gb004t-i-ml

1.0 DEVICE OVERVIEW

This document contains device-specific information for the following devices:

- PIC24FJ32GB002
- PIC24FJ64GB002
- PIC24FJ32GB004
- PIC24FJ64GB004

This family expands on the existing line of Microchip's 16-bit microcontrollers, combining an expanded peripheral feature set and enhanced computational performance with a new connectivity option: USB On-The-Go (OTG). The PIC24FJ64GB004 family provides a new platform for high-performance USB applications which may need more than an 8-bit platform, but do not require the power of a digital signal processor.

1.1 Core Features

1.1.1 16-BIT ARCHITECTURE

Central to all PIC24F devices is the 16-bit modified Harvard architecture, first introduced with Microchip's dsPIC® digital signal controllers. The PIC24F CPU core offers a wide range of enhancements, such as:

- 16-bit data and 24-bit address paths with the ability to move information between data and memory spaces
- Linear addressing of up to 12 Mbytes (program space) and 64 Kbytes (data)
- A 16-element working register array with built-in software stack support
- A 17 x 17 hardware multiplier with support for integer math
- Hardware support for 32 by 16-bit division
- An instruction set that supports multiple addressing modes and is optimized for high-level languages, such as 'C'
- Operational performance up to 16 MIPS

1.1.2 POWER-SAVING TECHNOLOGY

All of the devices in the PIC24FJ64GB004 family incorporate a range of features that can significantly reduce power consumption during operation. Key items include:

- **On-the-Fly Clock Switching:** The device clock can be changed under software control to the Timer1 source or the internal, Low-Power Internal RC Oscillator during operation, allowing the user to incorporate power-saving ideas into their software designs.
- **Doze Mode Operation:** When timing-sensitive applications, such as serial communications, require the uninterrupted operation of peripherals, the CPU clock speed can be selectively reduced, allowing incremental power savings without missing a beat.
- **Instruction-Based Power-Saving Modes:** There are three instruction-based power-saving modes:
  - Idle Mode – The core is shut down while leaving the peripherals active.
  - Sleep Mode – The core and peripherals that require the system clock are shut down, leaving the peripherals active that use their own clock or the clock from other devices.
  - Deep Sleep Mode – The core, peripherals (except RTCC and DSWDT), Flash and SRAM are shut down for optimal current savings to extend battery life for portable applications.

1.1.3 OSCILLATOR OPTIONS AND FEATURES

All of the devices in the PIC24FJ64GB004 family offer five different oscillator options, allowing users a range of choices in developing application hardware. These include:

- Two Crystal modes using crystals or ceramic resonators.
- Two External Clock modes offering the option of a divide-by-2 clock output.
- A Fast Internal RC Oscillator (FRC) with a nominal 8 MHz output, which can also be divided under software control to provide clock speeds as low as 31 kHz.
- A Phase Lock Loop (PLL) frequency multiplier available to the external oscillator modes and the FRC Oscillator, which allows clock speeds of up to 32 MHz.
- A separate Low-Power Internal RC Oscillator (LPRC) with a fixed 31 kHz output, which provides a low-power option for timing-insensitive applications.

The internal oscillator block also provides a stable reference source for the Fail-Safe Clock Monitor. This option constantly monitors the main clock source against a reference signal provided by the internal oscillator and enables the controller to switch to the internal oscillator, allowing for continued low-speed operation or a safe application shutdown.

1.1.4 EASY MIGRATION

Regardless of the memory size, all devices share the same rich set of peripherals, allowing for a smooth migration path as applications grow and evolve. The consistent pinout scheme used throughout the entire family also aids in migrating from one device to the next larger device.

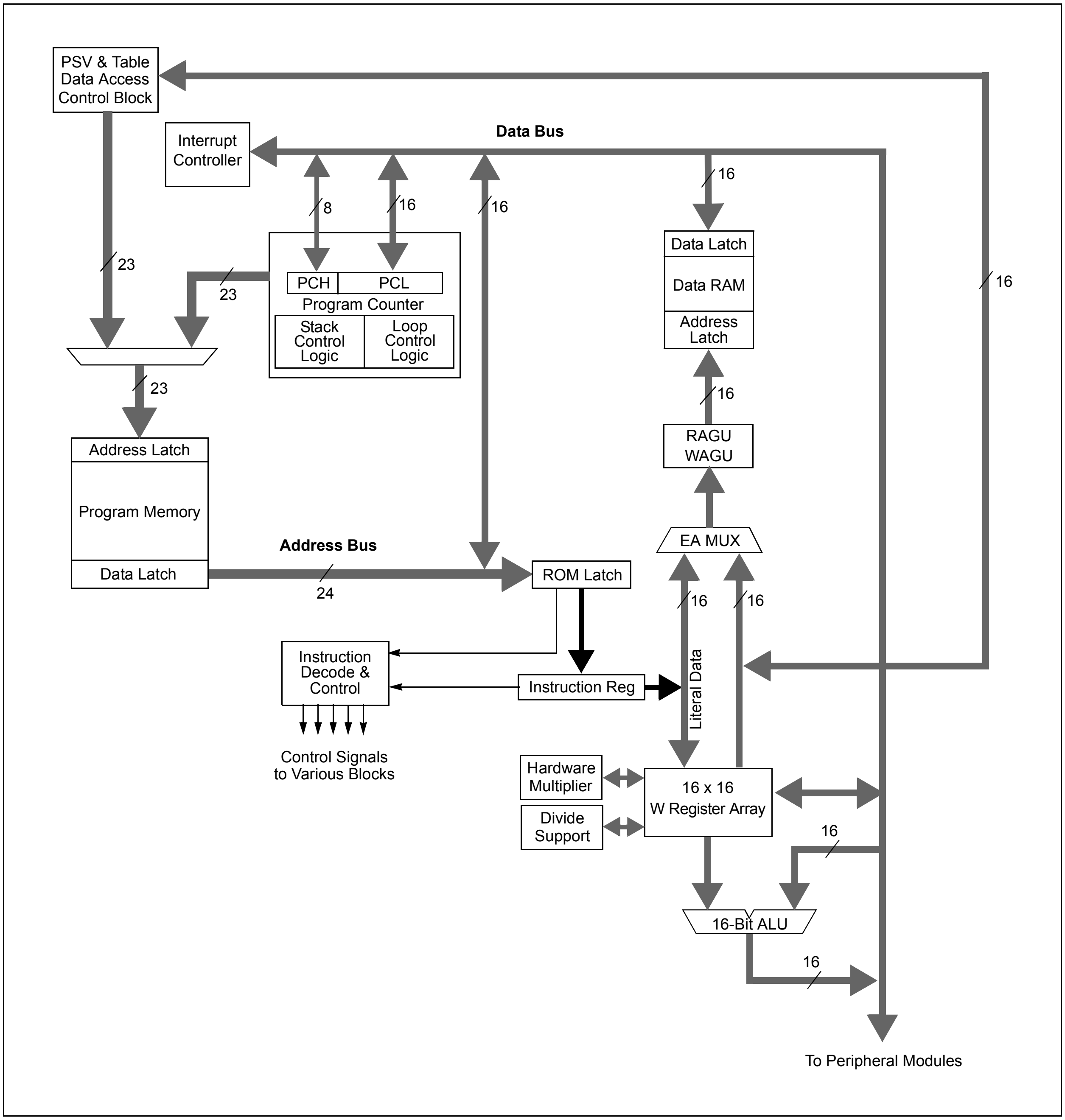
The PIC24F family is pin-compatible with devices in the dsPIC33 family, and shares some compatibility with the pinout schema for PIC18 and dsPIC30 devices. This extends the ability of applications to grow from the relatively simple, to the powerful and complex, yet still selecting a Microchip device.

TABLE 1-2: PIC24FJ64GB004 FAMILY PINOUT DESCRIPTIONS

Function	Pin Number			I/O	Input Buffer	Description
	28-Pin SPDIP/ SOIC/SSOP	28-Pin QFN	44-Pin QFN/TQFP			
AN0	2	27	19	I	ANA	A/D Analog Inputs.
AN1	3	28	20	I	ANA	
AN2	4	1	21	I	ANA	
AN3	5	2	22	I	ANA	
AN4	6	3	23	I	ANA	
AN5	7	4	24	I	ANA	
AN6	—	—	25	I	ANA	
AN7	—	—	26	I	ANA	
AN8	—	—	27	I	ANA	
AN9	26	23	15	I	ANA	
AN10	25	22	14	I	ANA	
AN11	24	21	11	I	ANA	
AN12	—	—	36	I	ANA	
ASCL1	3	28	20	I/O	I^2C	Alternate I2C1 Synchronous Serial Clock Input/Output.
ASDA1	2	27	19	I/O	I^2C	Alternate I2C1 Synchronous Serial Data Input/Output.
AVDD	—	—	17	P	—	Positive Supply for Analog modules.
AVSS	—	—	16	P	—	Ground Reference for Analog modules.
C1INA	7	4	24	I	ANA	Comparator 1 Input A.
C1INB	6	3	23	I	ANA	Comparator 1 Input B.
C1INC	24	21	11	I	ANA	Comparator 1 Input C.
C1IND	9	6	30	I	ANA	Comparator 1 Input D.
C2INA	5	2	22	I	ANA	Comparator 2 Input A.
C2INB	4	1	21	I	ANA	Comparator 2 Input B.
C2INC	12	9	34	I	ANA	Comparator 2 Input C.
C2IND	11	8	33	I	ANA	Comparator 2 Input D.
C3INA	26	23	15	I	ANA	Comparator 3 Input A.
C3INB	25	22	14	I	ANA	Comparator 3 Input B.
C3INC	2	27	19	I	ANA	Comparator 3 Input C.
C3IND	3	28	20	I	ANA	Comparator 3 Input D.
CLKI	9	6	30	I	ANA	Main Clock Input Connection.
CLKO	10	7	31	O	—	System Clock Output.

Legend: TTL = TTL input buffer
ANA = Analog level input/output
ST = Schmitt Trigger input buffer
I^2C™ = I^2C/SMBus input buffer

FIGURE 3-1: PIC24F CPU CORE BLOCK DIAGRAM



6.0 RESETS

Note:	This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the *"PIC24F Family Reference Manual"*, **Section 7. "Reset"** (DS39712).

The Reset module combines all Reset sources and controls the device Master Reset Signal, $\overline{\text{SYSRST}}$. The following is a list of device Reset sources:

- POR: Power-on Reset
- $\overline{\text{MCLR}}$: Pin Reset
- SWR: RESET Instruction
- WDT: Watchdog Timer Reset
- BOR: Brown-out Reset
- CM: Configuration Mismatch Reset
- TRAPR: Trap Conflict Reset
- IOPUWR: Illegal Opcode Reset
- UWR: Uninitialized W Register Reset

A simplified block diagram of the Reset module is shown in Figure 6-1.

Any active source of Reset will make the $\overline{\text{SYSRST}}$ signal active. Many registers associated with the CPU and peripherals are forced to a known Reset state. Most registers are unaffected by a Reset; their status is unknown on POR and unchanged by all other Resets.

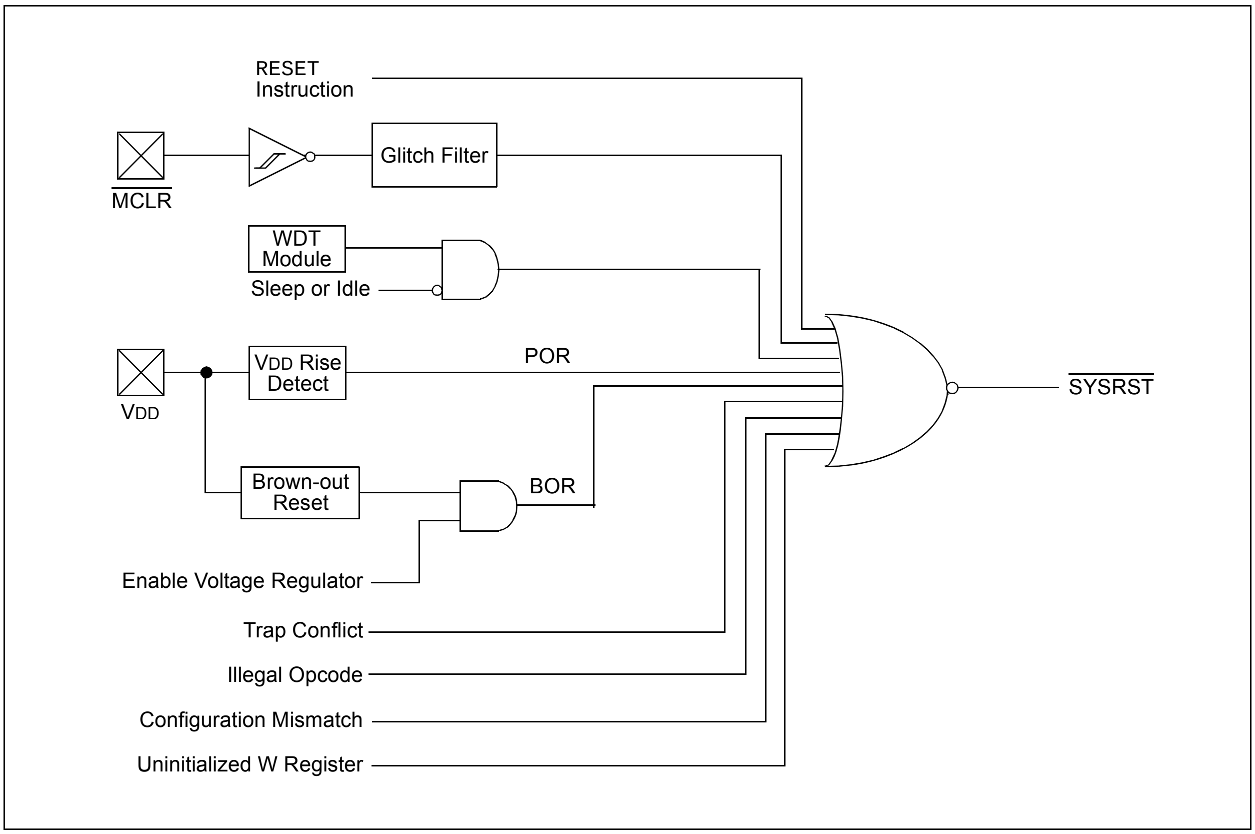
Note:	Refer to the specific peripheral or CPU section of this manual for register Reset states.

All types of device Reset will set a corresponding status bit in the RCON register to indicate the type of Reset (see Register 6-1). A Power-on Reset will clear all bits, except for the BOR and POR bits (RCON<1:0>), which are set. The user may set or clear any bit at any time during code execution. The RCON bits only serve as status bits. Setting a particular Reset status bit in software will not cause a device Reset to occur.

The RCON register also has other bits associated with the Watchdog Timer and device power-saving states. The function of these bits is discussed in other sections of this data sheet.

Note:	The status bits in the RCON register should be cleared after they are read so that the next RCON register value after a device Reset will be meaningful.

FIGURE 6-1: RESET SYSTEM BLOCK DIAGRAM



REGISTER 8-1: OSCCON: OSCILLATOR CONTROL REGISTER (CONTINUED)

bit 7	**CLKLOCK:** Clock Selection Lock Enabled bit If FSCM is enabled (FCKSM1 = 1): 1 = Clock and PLL selections are locked 0 = Clock and PLL selections are not locked and may be modified by setting the OSWEN bit If FSCM is disabled (FCKSM1 = 0): Clock and PLL selections are never locked and may be modified by setting the OSWEN bit.
bit 6	**IOLOCK:** I/O Lock Enable bit(2) 1 = I/O lock is active 0 = I/O lock is not active
bit 5	**LOCK:** PLL Lock Status bit(3) 1 = PLL module is in lock or PLL module start-up timer is satisfied 0 = PLL module is out of lock, PLL start-up timer is running or PLL is disabled
bit 4	**Unimplemented:** Read as '0'
bit 3	**CF:** Clock Fail Detect bit 1 = FSCM has detected a clock failure 0 = No clock failure has been detected
bit 2	**POSCEN:** Primary Oscillator Sleep Enable bit 1 = Primary oscillator continues to operate during Sleep mode 0 = Primary oscillator disabled during Sleep mode
bit 1	**SOSCEN:** 32 kHz Secondary Oscillator (SOSC) Enable bit 1 = Enable secondary oscillator 0 = Disable secondary oscillator
bit 0	**OSWEN:** Oscillator Switch Enable bit 1 = Initiate an oscillator switch to the clock source specified by the NOSC<2:0> bits 0 = Oscillator switch is complete

Note 1: Reset values for these bits are determined by the FNOSC Configuration bits.

2: The state of the IOLOCK bit can only be changed once an unlocking sequence has been executed. In addition, if the IOL1WAY Configuration bit is '1', once the IOLOCK bit is set, it cannot be cleared.

3: Also resets to '0' during any valid clock switch or whenever a non-PLL Clock mode is selected.

REGISTER 10-13: RPINR22: PERIPHERAL PIN SELECT INPUT REGISTER 22

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	—	SCK2R4	SCK2R3	SCK2R2	SCK2R1	SCK2R0
bit 15							bit 8

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	—	SDI2R4	SDI2R3	SDI2R2	SDI2R1	SDI2R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-13	**Unimplemented:** Read as ‘0’
bit 12-8	**SCK2R<4:0>:** Assign SPI2 Clock Input (SCK2IN) to Corresponding RPn or RPIn Pin bits
bit 7-5	**Unimplemented:** Read as ‘0’
bit 4-0	**SDI2R<4:0>:** Assign SPI2 Data Input (SDI2) to Corresponding RPn or RPIn Pin bits

REGISTER 10-14: RPINR23: PERIPHERAL PIN SELECT INPUT REGISTER 23

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	—	SS2R4	SS2R3	SS2R2	SS2R1	SS2R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-5	**Unimplemented:** Read as ‘0’
bit 4-0	**SS2R<4:0>:** Assign SPI2 Slave Select Input (SS2IN) to Corresponding RPn or RPIn Pin bits

REGISTER 12-1: TxCON: TIMER2 AND TIMER4 CONTROL REGISTER(3)

R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
TON	—	TSIDL	—	—	—	—	—
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	U-0
—	TGATE	TCKPS1	TCKPS0	T32(1)	—	TCS(2)	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15 **TON:** Timerx On bit
When TxCON<3> = 1:
1 = Starts 32-bit Timerx/y
0 = Stops 32-bit Timerx/y
When TxCON<3> = 0:
1 = Starts 16-bit Timerx
0 = Stops 16-bit Timerx

bit 14 **Unimplemented:** Read as ‘0’

bit 13 **TSIDL:** Stop in Idle Mode bit
1 = Discontinue module operation when device enters Idle mode
0 = Continue module operation in Idle mode

bit 12-7 **Unimplemented:** Read as ‘0’

bit 6 **TGATE:** Timerx Gated Time Accumulation Enable bit
When TCS = 1:
This bit is ignored.
When TCS = 0:
1 = Gated time accumulation is enabled
0 = Gated time accumulation is disabled

bit 5-4 **TCKPS<1:0>:** Timerx Input Clock Prescale Select bits
11 = 1:256
10 = 1:64
01 = 1:8
00 = 1:1

bit 3 **T32:** 32-Bit Timer Mode Select bit(1)
1 = Timerx and Timery form a single 32-bit timer
0 = Timerx and Timery act as two 16-bit timers
In 32-bit mode, T3CON control bits do not affect 32-bit timer operation.

bit 2 **Unimplemented:** Read as ‘0’

bit 1 **TCS:** Timerx Clock Source Select bit(2)
1 = External clock from pin, TxCK (on the rising edge)
0 = Internal clock (FOSC/2)

bit 0 **Unimplemented:** Read as ‘0’

Note 1: In 32-bit mode, the T3CON or T5CON control bits do not affect 32-bit timer operation.
2: If TCS = 1, RPINRx (TxCK) must be configured to an available RPn pin. For more information, see **Section 10.4 “Peripheral Pin Select (PPS)”**.
3: Changing the value of TxCON while the timer is running (TON = 1) causes the timer prescale counter to reset and is not recommended.

REGISTER 14-1: OCxCON1: OUTPUT COMPARE x CONTROL REGISTER 1 (CONTINUED)

bit 2-0 **OCM<2:0>:** Output Compare x Mode Select bits(1)

111 = Center-Aligned PWM mode on OCx
110 = Edge-Aligned PWM mode on OCx
101 = Double Compare Continuous Pulse mode: initialize OCx pin low, toggle OCx state continuously on alternate matches of OCxR and OCxRS
100 = Double Compare Single-Shot mode: initialize OCx pin low, toggle OCx state on matches of OCxR and OCxRS for one cycle
011 = Single Compare Continuous Pulse mode: compare events continuously toggle OCx pin
010 = Single Compare Single-Shot mode: initialize OCx pin high, compare event forces OCx pin low
001 = Single Compare Single-Shot mode: initialize OCx pin low, compare event forces OCx pin high
000 = Output compare channel is disabled

Note 1: The OCx output must also be configured to an available RPn pin. For more information, see **Section 10.4 "Peripheral Pin Select (PPS)"**.

2: The comparator module used for Fault input varies with the OCx module. OC1 and OC2 use Comparator 1; OC3 and OC4 use Comparator 2; OC5 uses Comparator 3.

18.1.2.3 VBUS Voltage Generation with External Devices

When operating as a USB host, either as an A-device in an OTG configuration or as an embedded host, VBUS must be supplied to the attached device. PIC24FJ64GB004 family devices have an internal VBUS boost assist to help generate the required 5V VBUS from the available voltages on the board. This is comprised of a simple PWM output to control a switch-mode power supply, and built-in comparators to monitor output voltage and limit current.

To enable voltage generation:

1. Verify that the USB module is powered (U1PWRC<0> = `1`) and that the VBUS discharge is disabled (U1OTGCON<0> = `0`).
2. Set the PWM period (U1PWMRRS<7:0>) and duty cycle (U1PWMRRS<15:8>) as required.
3. Select the required polarity of the output signal based on the configuration of the external circuit with the PWMPOL bit (U1PWMCON<9>).
4. Select the desired target voltage using the VBUSCHG bit (U1OTGCON<1>).
5. Enable the PWM counter by setting the CNTEN bit to '`1`' (U1PWMCON<8>).
6. Enable the PWM module by setting the PWMEN bit to '`1`' (U1PWMCON<15>).
7. Enable the VBUS generation circuit (U1OTGCON<3> = `1`).

Note:	This section describes the general process for VBUS voltage generation and control. Please refer to the "*PIC24F Family Reference Manual"* for additional examples.

18.1.3 USING AN EXTERNAL INTERFACE

Some applications may require the USB interface to be isolated from the rest of the system. PIC24FJ64GB004 family devices include a complete interface to communicate with and control an external USB transceiver, including the control of data line pull-ups and pull-downs. The VBUS voltage generation control circuit can also be configured for different VBUS generation topologies.

Please refer to the *"PIC24F Family Reference Manual"*, **"Section 27. USB On-The-Go (OTG)"** for information on using the external interface.

18.1.4 CALCULATING TRANSCEIVER POWER REQUIREMENTS

The USB transceiver consumes a variable amount of current depending on the characteristic impedance of the USB cable, the length of the cable, the VUSB supply voltage and the actual data patterns moving across the USB cable. Longer cables have larger capacitances and consume more total energy when switching output states. The total transceiver current consumption will be application-specific. Equation 18-1 can help estimate how much current actually may be required in Full-speed applications.

Please refer to the *"PIC24F Family Reference Manual"*, **"Section 27. USB On-The-Go (OTG)"** for a complete discussion on transceiver power consumption.

EQUATION 18-1: ESTIMATING USB TRANSCEIVER CURRENT CONSUMPTION

$$I_{XCVR} = \frac{(40\text{ mA} \cdot V_{USB} \cdot P_{ZERO} \cdot P_{IN} \cdot L_{CABLE})}{(3.3\text{V} \cdot 5\text{m})} + I_{PULLUP}$$

Legend: V_{USB} – Voltage applied to the VUSB pin in volts (3.0V to 3.6V).

P_{ZERO} – Percentage (in decimal) of the IN traffic bits sent by the PIC® microcontroller that are a value of '`0`'.

P_{IN} – Percentage (in decimal) of total bus bandwidth that is used for IN traffic.

L_{CABLE} – Length (in meters) of the USB cable. The USB 2.0 Specification requires that full-speed applications use cables no longer than 5m.

I_{PULLUP} – Current which the nominal, 1.5 kΩ pull-up resistor (when enabled) must supply to the USB cable.

REGISTER 18-9: U1ADDR: USB ADDRESS REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
LSPDEN(1)	ADDR6	ADDR5	ADDR4	ADDR3	ADDR2	ADDR1	ADDR0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-8 **Unimplemented:** Read as ‘0’

bit 7 **LSPDEN:** Low-Speed Enable Indicator bit(1)
- 1 = USB module operates at low speed
- 0 = USB module operates at full speed

bit 6-0 **ADDR<6:0>:** USB Device Address bits

Note 1: Host mode only. In Device mode, this bit is unimplemented and read as ‘0’.

REGISTER 18-10: U1TOK: USB TOKEN REGISTER (HOST MODE ONLY)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PID3	PID2	PID1	PID0	EP3	EP2	EP1	EP0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-8 **Unimplemented:** Read as ‘0’

bit 7-4 **PID<3:0>:** Token Type Identifier bits
- 1101 = SETUP (TX) token type transaction(1)
- 1001 = IN (RX) token type transaction(1)
- 0001 = OUT (TX) token type transaction(1)

bit 3-0 **EP<3:0>:** Token Command Endpoint Address bits
This value must specify a valid endpoint on the attached device.

Note 1: All other combinations are reserved and are not to be used.

19.0 PARALLEL MASTER PORT (PMP)

Note:	This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the *"PIC24F Family Reference Manual"*, **Section 13. "Parallel Master Port (PMP)"** (DS39713).

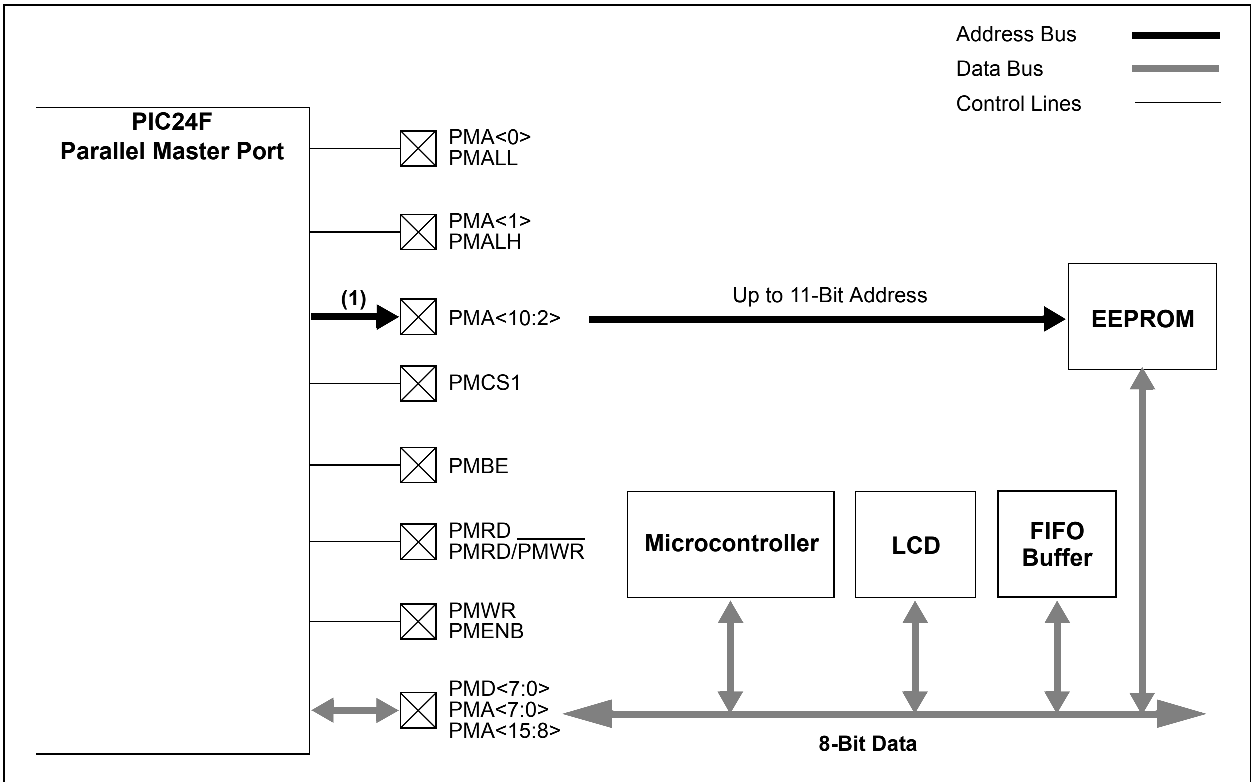
The Parallel Master Port (PMP) module is a parallel, 8-bit I/O module, specifically designed to communicate with a wide variety of parallel devices, such as communication peripherals, LCDs, external memory devices and microcontrollers. Because the interface to parallel peripherals varies significantly, the PMP is highly configurable.

Note:	A number of the pins for the PMP are not present on PIC24FJ64GB0 family devices. Refer to the specific device's pinout to determine which pins are available.

Key features of the PMP module include:

- Up to 16 Programmable Address Lines
- One Chip Select Line
- Programmable Strobe Options:
  - Individual Read and Write Strobes or;
  - Read/Write Strobe with Enable Strobe
- Address Auto-Increment/Auto-Decrement
- Programmable Address/Data Multiplexing
- Programmable Polarity on Control Signals
- Legacy Parallel Slave Port Support
- Enhanced Parallel Slave Support:
  - Address Support
  - 4-Byte Deep Auto-Incrementing Buffer
- Programmable Wait States
- Selectable Input Voltage Levels

FIGURE 19-1: PMP MODULE OVERVIEW



Note 1: PMA<10:2> bits are not available on 28-pin devices.

20.2.5 RTCVAL REGISTER MAPPINGS

REGISTER 20-4: YEAR: YEAR VALUE REGISTER(1)

U-0, HSC	U-0, HSC	U-0, HSC	U-0, HSC	U-0, HSC	U-0, HSC	U-0, HSC	U-0, HSC
—	—	—	—	—	—	—	—
bit 15							bit 8

R/W-x, HSC	R/W-x, HSC	R/W-x, HSC	R/W-x, HSC	R/W-x, HSC	R/W-x, HSC	R/W-x, HSC	R/W-x, HSC
YRTEN3	YRTEN2	YRTEN1	YRTEN0	YRONE3	YRONE2	YRONE1	YRONE0
bit 7							bit 0

Legend:	HSC = Hardware Settable/Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-8 **Unimplemented:** Read as ‘0’

bit 7-4 **YRTEN<3:0>:** Binary Coded Decimal Value of Year’s Tens Digit bits
Contains a value from 0 to 9.

bit 3-0 **YRONE<3:0>:** Binary Coded Decimal Value of Year’s Ones Digit bits
Contains a value from 0 to 9.

Note 1: A write to the YEAR register is only allowed when RTCWREN = 1.

REGISTER 20-5: MTHDY: MONTH AND DAY VALUE REGISTER(1)

U-0, HSC	U-0, HSC	U-0, HSC	R/W-x, HSC	R/W-x, HSC	R/W-x, HSC	R/W-x, HSC	R/W-x, HSC
—	—	—	MTHTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0
bit 15							bit 8

U-0, HSC	U-0, HSC	R/W-x, HSC	R/W-x, HSC	R/W-x, HSC	R/W-x, HSC	R/W-x, HSC	R/W-x, HSC
—	—	DAYTEN1	DAYTEN0	DAYONE3	DAYONE2	DAYONE1	DAYONE0
bit 7							bit 0

Legend:	HSC = Hardware Settable/Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-13 **Unimplemented:** Read as ‘0’

bit 12 **MTHTEN0:** Binary Coded Decimal Value of Month’s Tens Digit bit
Contains a value of ‘0’ or ‘1’.

bit 11-8 **MTHONE<3:0>:** Binary Coded Decimal Value of Month’s Ones Digit bits
Contains a value from 0 to 9.

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-4 **DAYTEN<1:0>:** Binary Coded Decimal Value of Day’s Tens Digit bits
Contains a value from 0 to 3.

bit 3-0 **DAYONE<3:0>:** Binary Coded Decimal Value of Day’s Ones Digit bits
Contains a value from 0 to 9.

Note 1: A write to this register is only allowed when RTCWREN = 1.

REGISTER 20-10: ALMINSEC: ALARM MINUTES AND SECONDS VALUE REGISTER

U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
bit 15							bit 8

U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15 **Unimplemented:** Read as ‘0’

bit 14-12 **MINTEN<2:0>:** Binary Coded Decimal Value of Minute’s Tens Digit bits
Contains a value from 0 to 5.

bit 11-8 **MINONE<3:0>:** Binary Coded Decimal Value of Minute’s Ones Digit bits
Contains a value from 0 to 9.

bit 7 **Unimplemented:** Read as ‘0’

bit 6-4 **SECTEN<2:0>:** Binary Coded Decimal Value of Second’s Tens Digit bits
Contains a value from 0 to 5.

bit 3-0 **SECONE<3:0>:** Binary Coded Decimal Value of Second’s Ones Digit bits
Contains a value from 0 to 9.

20.3 Calibration

The real-time crystal input can be calibrated using the periodic auto-adjust feature. When calibrated, the RTCC can provide an error of less than 3 seconds per month. This is accomplished by finding the number of error clock pulses and storing the value into the lower half of the RCFGCAL register. The 8-bit signed value loaded into the lower half of RCFGCAL is multiplied by four and will either be added or subtracted from the RTCC timer, once every minute. Refer to the steps below for RTCC calibration:

1. Using another timer resource on the device; the user must find the error of the 32.768 kHz crystal.
2. Once the error is known, it must be converted to the number of error clock pulses per minute.
3. a) If the oscillator is faster than ideal (negative result from step 2), the RCFGCAL register value must be negative. This causes the specified number of clock pulses to be subtracted from the timer counter, once every minute.

   b) If the oscillator is slower than ideal (positive result from step 2), the RCFGCAL register value must be positive. This causes the specified number of clock pulses to be subtracted from the timer counter, once every minute.

Divide the number of error clocks per minute by 4 to get the correct calibration value and load the RCFGCAL register with the correct value. (Each 1-bit increment in the calibration adds or subtracts 4 pulses.)

EQUATION 20-1:

$$(\text{Ideal Frequency}\dagger - \text{Measured Frequency}) * 60 = \text{Clocks per Minute}$$

† Ideal Frequency = 32,768 Hz

Writes to the lower half of the RCFGCAL register should only occur when the timer is turned off or immediately after the rising edge of the seconds pulse.

Note: It is up to the user to include, in the error value, the initial error of the crystal drift due to temperature and drift due to crystal aging.

20.4 Alarm

- Configurable from half second to one year
- Enabled using the ALRMEN bit (ALCFGRPT<15>)
- One-time alarm and repeat alarm options are available

20.4.1 CONFIGURING THE ALARM

The alarm feature is enabled using the ALRMEN bit. This bit is cleared when an alarm is issued. Writes to ALRMVAL should only take place when ALRMEN = `0`.

As displayed in Figure 20-2, the interval selection of the alarm is configured through the AMASK bits (ALCFGRPT<13:10>). These bits determine which and how many digits of the alarm must match the clock value for the alarm to occur.

The alarm can also be configured to repeat based on a preconfigured interval. The amount of times this occurs, once the alarm is enabled, is stored in the ARPT<7:0> bits (ALCFGRPT<7:0>). When the value of the ARPT bits equals 00h and the CHIME bit (ALCFGRPT<14>) is cleared, the repeat function is disabled and only a single alarm will occur. The alarm can be repeated up to 255 times by loading ARPT<7:0> with FFh.

After each alarm is issued, the value of the ARPT bits is decremented by one. Once the value has reached 00h, the alarm will be issued one last time, after which, the ALRMEN bit will be cleared automatically and the alarm will turn off.

Indefinite repetition of the alarm can occur if the CHIME bit = `1`. Instead of the alarm being disabled when the value of the ARPT bits reaches 00h, it rolls over to FFh and continues counting indefinitely while CHIME is set.

20.4.2 ALARM INTERRUPT

At every alarm event, an interrupt is generated. In addition, an alarm pulse output is provided that operates at half the frequency of the alarm. This output is completely synchronous to the RTCC clock and can be used as a trigger clock to other peripherals.

Note: Changing any of the registers, other than the RCFGCAL and ALCFGRPT registers, and the CHIME bit while the alarm is enabled (ALRMEN = `1`), can result in a false alarm event leading to a false alarm interrupt. To avoid a false alarm event, the timer and alarm values should only be changed while the alarm is disabled (ALRMEN = `0`). It is recommended that the ALCFGRPT register and CHIME bit be changed when RTCSYNC = `0`.

REGISTER 21-1: CRCCON1: CRC CONTROL REGISTER 1

R/W-0	U-0	R/W-0	R-0	R-0	R-0	R-0	R-0
CRCEN	—	CSIDL	VWORD4	VWORD3	VWORD2	VWORD1	VWORD0
bit 15							bit 8

R-0, HCS	R-1, HCS	R/W-0	R/W-0, HC	R/W-0	U-0	U-0	U-0
CRCFUL	CRCMPT	CRCISEL	CRCGO	LENDIAN	—	—	—
bit 7							bit 0

Legend:	HC = Hardware Clearable bit	HCS = Hardware Clearable/Settable bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15 **CRCEN**: CRC Enable bit
1 = Module is enabled
0 = Module is enabled. All state machines, pointers and CRCWDAT/CRCDAT are reset; other SFRs are NOT reset

bit 14 **Unimplemented:** Read as ‘0’

bit 13 **CSIDL:** CRC Stop in Idle Mode bit
1 = Discontinue module operation when device enters Idle mode
0 = Continue module operation in Idle mode

bit 12-8 **VWORD<4:0>:** Pointer Value bits
Indicates the number of valid words in the FIFO. Has a maximum value of 8 when PLEN<3:0> > 7 or 16 when PLEN<3:0> ≤ 7.

bit 7 **CRCFUL**: FIFO Full bit
1 = FIFO is full
0 = FIFO is not full

bit 6 **CRCMPT:** FIFO Empty Bit
1 = FIFO is empty
0 = FIFO is not empty

bit 5 **CRCISEL:** CRC interrupt Selection bit
1 = Interrupt on FIFO is empty; CRC calculation is not complete
0 = Interrupt on shift is complete and CRCWDAT result is ready

bit 4 **CRCGO:** Start CRC bit
1 = Start CRC serial shifter
0 = CRC serial shifter is turned off

bit 3 **LENDIAN:** Data Shift Direction Select bit
1 = Data word is shifted into the CRC starting with the LSb (little endian)
0 = Data word is shifted into the CRC starting with the MSb (big endian)

bit 2-0 **Unimplemented:** Read as ‘0’

23.0 TRIPLE COMPARATOR MODULE

Note:	This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the associated *"PIC24F Family Reference Manual"*, **Section 46. "Scalable Comparator Module"** (DS39734).

The triple comparator module provides three dual input comparators. The inputs to the comparator can be configured to use any one of four external analog inputs, as well as voltage reference inputs from the voltage reference generator and band gap reference.

The comparator outputs may be directly connected to the CxOUT pins. When the respective COE equals '1', the I/O pad logic makes the unsynchronized output of the comparator available on the pin.

A simplified block diagram of the module in shown in Figure 23-1. Diagrams of the possible individual comparator configurations are shown in Figure 23-2.

Each comparator has its own control register, CMxCON (Register 23-1), for enabling and configuring its operation. The output and event status of all three comparators are provided in the CMSTAT register (Register 23-2).

FIGURE 23-1: TRIPLE COMPARATOR MODULE BLOCK DIAGRAM

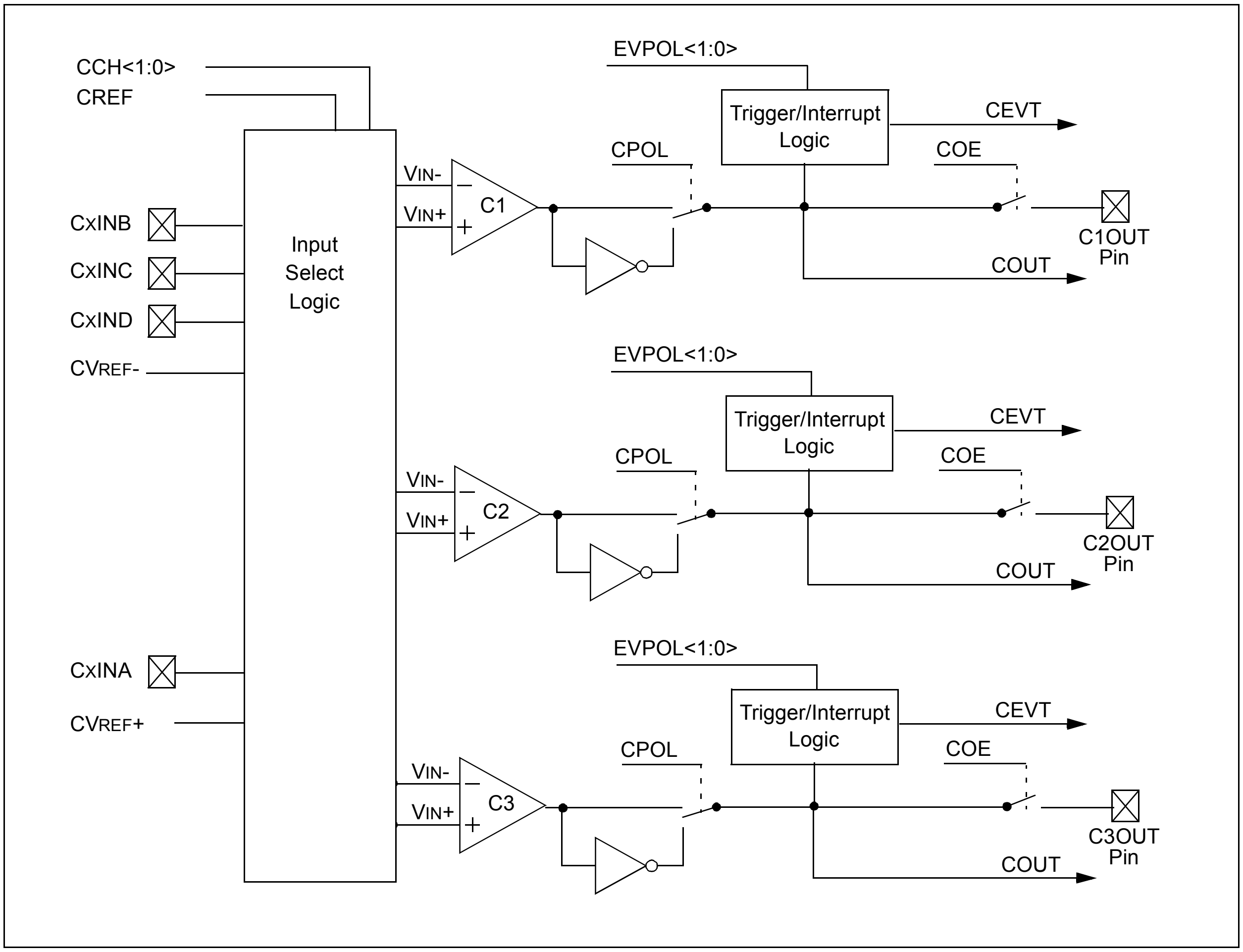


TABLE 28-2: INSTRUCTION SET OVERVIEW

Assembly Mnemonic	Assembly Syntax		Description	# of Words	# of Cycles	Status Flags Affected
ADD	ADD	f	f = f + WREG	1	1	C, DC, N, OV, Z
	ADD	f,WREG	WREG = f + WREG	1	1	C, DC, N, OV, Z
	ADD	#lit10,Wn	Wd = lit10 + Wd	1	1	C, DC, N, OV, Z
	ADD	Wb,Ws,Wd	Wd = Wb + Ws	1	1	C, DC, N, OV, Z
	ADD	Wb,#lit5,Wd	Wd = Wb + lit5	1	1	C, DC, N, OV, Z
ADDC	ADDC	f	f = f + WREG + (C)	1	1	C, DC, N, OV, Z
	ADDC	f,WREG	WREG = f + WREG + (C)	1	1	C, DC, N, OV, Z
	ADDC	#lit10,Wn	Wd = lit10 + Wd + (C)	1	1	C, DC, N, OV, Z
	ADDC	Wb,Ws,Wd	Wd = Wb + Ws + (C)	1	1	C, DC, N, OV, Z
	ADDC	Wb,#lit5,Wd	Wd = Wb + lit5 + (C)	1	1	C, DC, N, OV, Z
AND	AND	f	f = f .AND. WREG	1	1	N, Z
	AND	f,WREG	WREG = f .AND. WREG	1	1	N, Z
	AND	#lit10,Wn	Wd = lit10 .AND. Wd	1	1	N, Z
	AND	Wb,Ws,Wd	Wd = Wb .AND. Ws	1	1	N, Z
	AND	Wb,#lit5,Wd	Wd = Wb .AND. lit5	1	1	N, Z
ASR	ASR	f	f = Arithmetic Right Shift f	1	1	C, N, OV, Z
	ASR	f,WREG	WREG = Arithmetic Right Shift f	1	1	C, N, OV, Z
	ASR	Ws,Wd	Wd = Arithmetic Right Shift Ws	1	1	C, N, OV, Z
	ASR	Wb,Wns,Wnd	Wnd = Arithmetic Right Shift Wb by Wns	1	1	N, Z
	ASR	Wb,#lit5,Wnd	Wnd = Arithmetic Right Shift Wb by lit5	1	1	N, Z
BCLR	BCLR	f,#bit4	Bit Clear f	1	1	None
	BCLR	Ws,#bit4	Bit Clear Ws	1	1	None
BRA	BRA	C,Expr	Branch if Carry	1	1 (2)	None
	BRA	GE,Expr	Branch if Greater than or Equal	1	1 (2)	None
	BRA	GEU,Expr	Branch if Unsigned Greater than or Equal	1	1 (2)	None
	BRA	GT,Expr	Branch if Greater than	1	1 (2)	None
	BRA	GTU,Expr	Branch if Unsigned Greater than	1	1 (2)	None
	BRA	LE,Expr	Branch if Less than or Equal	1	1 (2)	None
	BRA	LEU,Expr	Branch if Unsigned Less than or Equal	1	1 (2)	None
	BRA	LT,Expr	Branch if Less than	1	1 (2)	None
	BRA	LTU,Expr	Branch if Unsigned Less than	1	1 (2)	None
	BRA	N,Expr	Branch if Negative	1	1 (2)	None
	BRA	NC,Expr	Branch if Not Carry	1	1 (2)	None
	BRA	NN,Expr	Branch if Not Negative	1	1 (2)	None
	BRA	NOV,Expr	Branch if Not Overflow	1	1 (2)	None
	BRA	NZ,Expr	Branch if Not Zero	1	1 (2)	None
	BRA	OV,Expr	Branch if Overflow	1	1 (2)	None
	BRA	Expr	Branch Unconditionally	1	2	None
	BRA	Z,Expr	Branch if Zero	1	1 (2)	None
	BRA	Wn	Computed Branch	1	2	None
BSET	BSET	f,#bit4	Bit Set f	1	1	None
	BSET	Ws,#bit4	Bit Set Ws	1	1	None
BSW	BSW.C	Ws,Wb	Write C bit to Ws<Wb>	1	1	None
	BSW.Z	Ws,Wb	Write Z bit to Ws<Wb>	1	1	None
BTG	BTG	f,#bit4	Bit Toggle f	1	1	None
	BTG	Ws,#bit4	Bit Toggle Ws	1	1	None
BTSC	BTSC	f,#bit4	Bit Test f, Skip if Clear	1	1 (2 or 3)	None
	BTSC	Ws,#bit4	Bit Test Ws, Skip if Clear	1	1 (2 or 3)	None

TABLE 29-7: DC CHARACTERISTICS: POWER-DOWN PERIPHERAL MODULE Δ CURRENT (I_{PD}) (CONTINUED)

DC CHARACTERISTICS				Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ T_A ≤ +85°C for Industrial -40°C ≤ T_A ≤ +125°C for Extended		
Parameter No.	**Typical[1]**	**Max**	**Units**	**Conditions**		
Δ Power-Down Current (I_{PD}): PMD Bits are Set, PMSLP Bit is '0'[2]						
DC63	1.8	2.3	µA	-40°C	2.0V[3]	32 kHz Crystal with RTCC, DSWDT or Timer1: ΔI_{SOSC}; SOSCSEL = 11[5]
DC63a	1.8	2.7	µA	+25°C	2.0V[3]	32 kHz Crystal with RTCC, DSWDT or Timer1: ΔI_{SOSC}; SOSCSEL = 11[5]
DC63i	1.8	3.0	µA	+60°C	2.0V[3]	32 kHz Crystal with RTCC, DSWDT or Timer1: ΔI_{SOSC}; SOSCSEL = 11[5]
DC63b	1.8	3.0	µA	+85°C	2.0V[3]	32 kHz Crystal with RTCC, DSWDT or Timer1: ΔI_{SOSC}; SOSCSEL = 11[5]
DC63m	2.2	3.3	µA	+125C	2.0V[3]	32 kHz Crystal with RTCC, DSWDT or Timer1: ΔI_{SOSC}; SOSCSEL = 11[5]
DC63c	2	2.7	µA	-40°C	2.5V[3]	32 kHz Crystal with RTCC, DSWDT or Timer1: ΔI_{SOSC}; SOSCSEL = 11[5]
DC63d	2	2.9	µA	+25°C	2.5V[3]	32 kHz Crystal with RTCC, DSWDT or Timer1: ΔI_{SOSC}; SOSCSEL = 11[5]
DC63j	2	3.2	µA	+60°C	2.5V[3]	32 kHz Crystal with RTCC, DSWDT or Timer1: ΔI_{SOSC}; SOSCSEL = 11[5]
DC63e	2	3.5	µA	+85°C	2.5V[3]	32 kHz Crystal with RTCC, DSWDT or Timer1: ΔI_{SOSC}; SOSCSEL = 11[5]
DC63n	2.5	3.8	µA	+125C	2.5V[3]	32 kHz Crystal with RTCC, DSWDT or Timer1: ΔI_{SOSC}; SOSCSEL = 11[5]
DC63f	2.25	3.0	µA	-40°C	3.3V[4]	32 kHz Crystal with RTCC, DSWDT or Timer1: ΔI_{SOSC}; SOSCSEL = 11[5]
DC63g	2.25	3.0	µA	+25°C	3.3V[4]	32 kHz Crystal with RTCC, DSWDT or Timer1: ΔI_{SOSC}; SOSCSEL = 11[5]
DC63k	2.25	3.3	µA	+60°C	3.3V[4]	32 kHz Crystal with RTCC, DSWDT or Timer1: ΔI_{SOSC}; SOSCSEL = 11[5]
DC63h	2.25	3.5	µA	+85°C	3.3V[4]	32 kHz Crystal with RTCC, DSWDT or Timer1: ΔI_{SOSC}; SOSCSEL = 11[5]
DC63p	2.8	4.0	µA	+125C	3.3V[4]	32 kHz Crystal with RTCC, DSWDT or Timer1: ΔI_{SOSC}; SOSCSEL = 11[5]
DC71c	0.001	0.25	µA	-40°C	2.5V[4]	Deep Sleep BOR: ΔI_{DSBOR}[5]
DC71d	0.03	0.25	µA	+25°C	2.5V[4]	Deep Sleep BOR: ΔI_{DSBOR}[5]
DC71j	0.05	0.60	µA	+60°C	2.5V[4]	Deep Sleep BOR: ΔI_{DSBOR}[5]
DC71e	0.08	2.0	µA	+85°C	2.5V[4]	Deep Sleep BOR: ΔI_{DSBOR}[5]
DC71a	3.9	10	µA	+125C	2.5V[4]	Deep Sleep BOR: ΔI_{DSBOR}[5]
DC71f	0.001	0.50	µA	-40°C	3.3V[4]	Deep Sleep BOR: ΔI_{DSBOR}[5]
DC71g	0.03	0.50	µA	+25°C	3.3V[4]	Deep Sleep BOR: ΔI_{DSBOR}[5]
DC71k	0.05	0.75	µA	+60°C	3.3V[4]	Deep Sleep BOR: ΔI_{DSBOR}[5]
DC71h	0.08	2.5	µA	+85°C	3.3V[4]	Deep Sleep BOR: ΔI_{DSBOR}[5]
DC71b	3.9	12.5	µA	+125C	3.3V[4]	Deep Sleep BOR: ΔI_{DSBOR}[5]

Note 1: Data in the Typical column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: Peripheral IPD deltas are measured with the device in Sleep mode (all peripherals and clocks shut down). All I/Os are configured as inputs and pulled high. Only the peripheral or clock being measured is enabled. PMSLP bit is clear and the Peripheral Module Disable bits (PMD) for all unused peripherals are set.

3: On-chip voltage regulator disabled (DISVREG tied to V_{DD}).

4: On-chip voltage regulator enabled (DISVREG tied to V_{SS}). Low-Voltage Detect (LVD) and Brown-out Detect (BOD) are enabled.

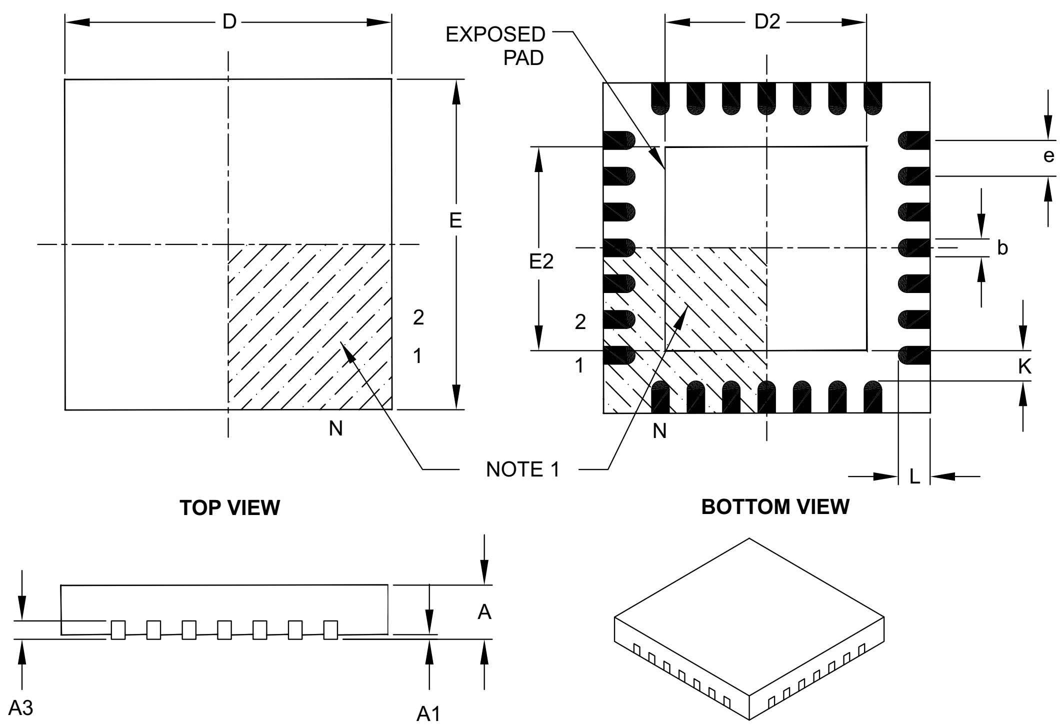
5: The Δ current is the additional current consumed when the module is enabled. This current should be added to the base I_{PD} current.

30.2 Package Details

The following sections give the technical details of the packages.

28-Lead Plastic Quad Flat, No Lead Package (ML) – 6x6 mm Body [QFN] with 0.55 mm Contact Length

Note:	For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		28	
Pitch	e		0.65 BSC	
Overall Height	A	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Contact Thickness	A3		0.20 REF	
Overall Width	E		6.00 BSC	
Exposed Pad Width	E2	3.65	3.70	4.20
Overall Length	D		6.00 BSC	
Exposed Pad Length	D2	3.65	3.70	4.20
Contact Width	b	0.23	0.30	0.35
Contact Length	L	0.50	0.55	0.70
Contact-to-Exposed Pad	K	0.20	–	–

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated.
3. Dimensioning and tolerancing per ASME Y14.5M.

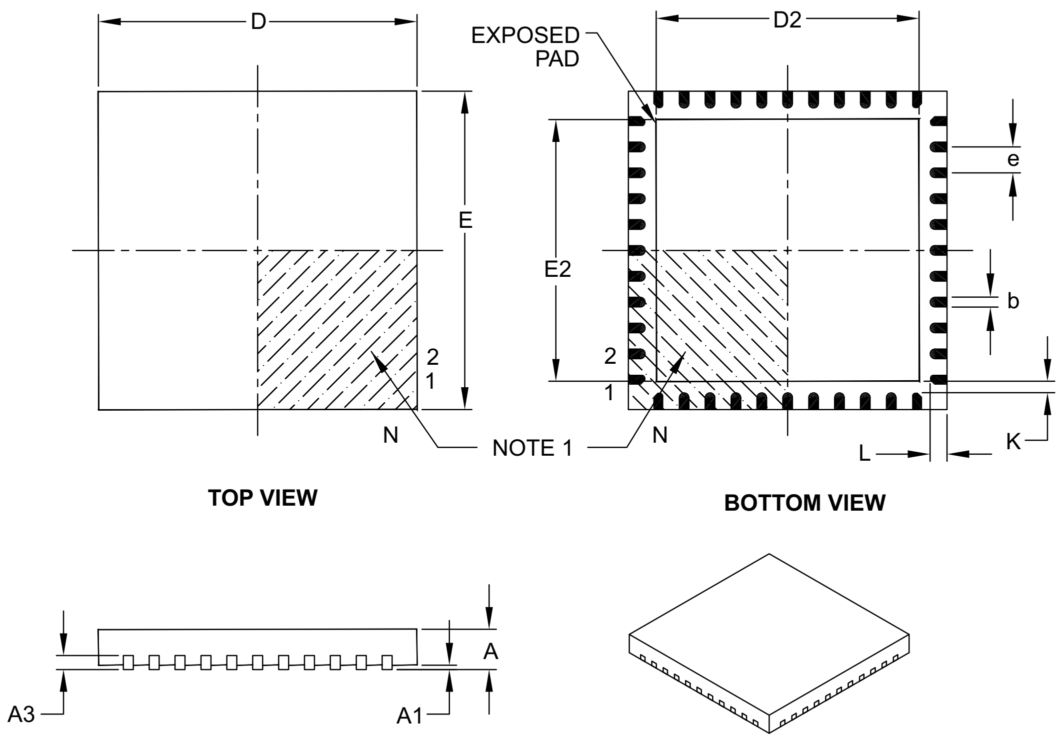
   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

   REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-105B

44-Lead Plastic Quad Flat, No Lead Package (ML) – 8x8 mm Body [QFN]

Note:	For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	MILLIMETERS		
	Dimension Limits	MIN	NOM	MAX
Number of Pins	N		44	
Pitch	e		0.65 BSC	
Overall Height	A	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Contact Thickness	A3		0.20 REF	
Overall Width	E		8.00 BSC	
Exposed Pad Width	E2	6.30	6.45	6.80
Overall Length	D		8.00 BSC	
Exposed Pad Length	D2	6.30	6.45	6.80
Contact Width	b	0.25	0.30	0.38
Contact Length	L	0.30	0.40	0.50
Contact-to-Exposed Pad	K	0.20	–	–

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated.
3. Dimensioning and tolerancing per ASME Y14.5M.

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

   REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-103B